AUTOMOTIVE



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Vishay Siliconix

Automotive N-Channel 40 V (D-S) 175 °C MOSFET



PRODUCT SUMMARY	
V _{DS} (V)	40
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 \text{ V}$	0.0021
I _D (A)	266
Configuration	Single
Package	PowerPAK SO-8L

FEATURES

- TrenchFET® Gen IV power MOSFET
- AEC-Q101 qualified
- 100 % Rq and UIS tested
- Q_{gd}/Q_{gs} ratio < 1 optimizes switching characteristics
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

N-Channel MOSFET

88

-55 to +175

260

°C



ABSOLUTE MAXIMUM RATINGS	$(T_C = 25 ^{\circ}C, unless)$	otherwise noted)		
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage	V _{DS}	40	V	
Gate-source voltage		V _{GS}	± 20	V
Continuous drain current	T _C = 25 °C T _C = 125 °C	- I _D	266	
	T _C = 125 °C		154	
Continuous source current (diode conduction)	Is	239	Α	
Pulsed drain current ^a		I _{DM}	385	
Single pulse avalanche current	J 0.1 ml J	I _{AS}	35	
Single pulse avalanche energy	L = 0.1 mH	E _{AS}	61	mJ
	T _C = 25 °C		263	

 P_D

T_J, T_{stg}

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-ambient	PCB mount b	R_{thJA}	42	°C/W
Junction-to-case (drain)		R_{thJC}	0.57	C/VV

 $T_C = 125 \, ^{\circ}C$

Notes

a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %

Operating junction and storage temperature range

Soldering recommendations (peak temperature) ^c

b. When mounted on 1" square PCB (FR4 material)

Maximum power dissipation a

c. See solder profile (www.vishay.com/doc?73257). The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection



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SPECIFICATIONS ($T_C = 25 ^{\circ}C$, PARAMETER	SYMBOL		T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						1	91111
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0$, $I_D = 250 \mu A$		40	-	_	l
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	2.5	3.0	3.5	V
Gate-source leakage	I _{GSS}		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$		-	± 100	nA
-		$V_{GS} = 0 V$	V _{DS} = 40 V	-	-	1	
Zero gate voltage drain current	I _{DSS}	V _{GS} = 0 V	V _{DS} = 40 V, T _J = 125 °C	-	-	50	μA
		V _{GS} = 0 V	V _{DS} = 40 V, T _J = 175 °C	-	-	250	
On-state drain current a	I _{D(on)}	V _{GS} = 10 V	V _{DS} ≥ 5 V	30	-	-	Α
		V _{GS} = 10 V	I _D = 15 A	-	0.0017	0.0021	
Drain-source on-state resistance a	R _{DS(on)}	V _{GS} = 10 V	I _D = 15 A, T _J = 125 °C	-	-	0.0032	Ω
	, ,	V _{GS} = 10 V	I _D = 15 A, T _J = 175 °C	-	-	0.0037	
Forward transconductance b	9 _{fs}	V _{DS}	= 15 V, I _D = 10 A	-	55	-	S
Dynamic ^b							
Input capacitance	C _{iss}			-	2964	3855	
Output capacitance	C _{oss}	$V_{GS} = 0 V$	$V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$	-	963	1255	рF
Reverse transfer capacitance	C _{rss}			-	48	62	
Total gate charge ^c	Qg			-	49.2	64	
Gate-source charge c	Q _{gs}	V _{GS} = 10 V	$V_{DS} = 20 \text{ V}, I_{D} = 30 \text{ A}$	-	14.6	-	nC
Gate-drain charge c	Q_{gd}			-	11.8	-	
Gate resistance	Rg		f = 1 MHz	0.8	1.85	3	Ω
Turn-on delay time ^c	t _{d(on)}			-	15	22	
Rise time ^c	t _r	V _{DD} =	20 V, R_L = 0.67 Ω	-	19	28	
Turn-off delay time ^c	t _{d(off)}	$I_D \cong 30 A$,	$V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	26	40	ns
Fall time ^c	t _f				9	13	
Source-Drain Diode Ratings and Chara	acteristics ^b						
Pulsed current ^a	I _{SM}			-	-	385	Α
Forward voltage	V_{SD}	I _F = 15 A, V _{GS} = 0 V		-	-	1.1	V
Body diode reverse recovery time	t _{rr}			-	52	67	ns
Body diode reverse recovery charge	Q _{rr}]	Λ di/dt = 100 Λ/μο	-	40	59	nC
Reverse recovery fall time	ta] I _F = 10	A, di/dt = 100 A/μs	-	22	33	
Reverse recovery rise time	t _b	7		-	23	35	ns
Body diode peak reverse recovery current	I _{RM(REC)}			-	1.5	2.2	Α

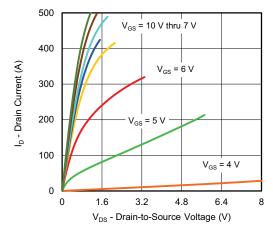
Notes

- a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %
- b. Guaranteed by design, not subject to production testing
- c. Independent of operating temperature

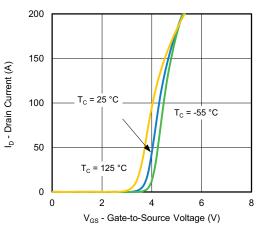
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



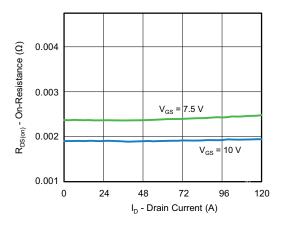
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



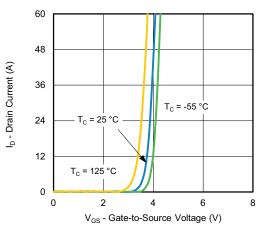
Output Characteristics



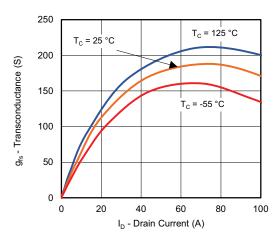
Transfer Characteristics



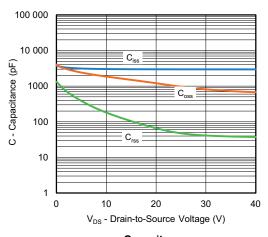
On-Resistance vs. Drain Current



Transfer Characteristics



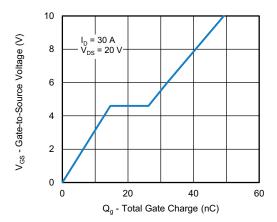
Transconductance



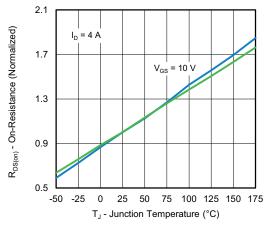
Capacitance



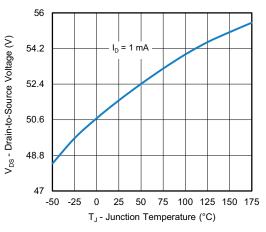
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



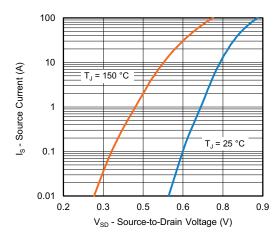
Gate Charge



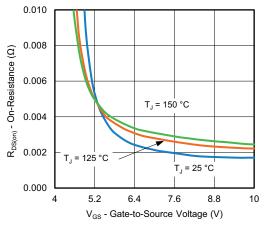
On-Resistance vs. Junction Temperature



Drain Source Breakdown vs. Junction Temperature



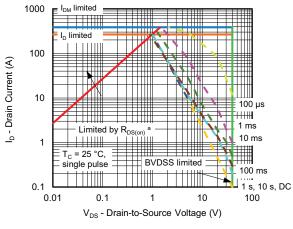
Source Drain Diode Forward Voltage



On-Resistance vs. Gate-to Source Voltage

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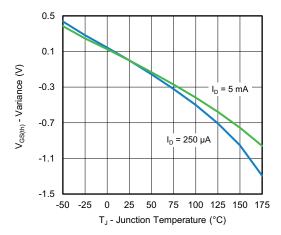
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



Safe Operating Area

Note

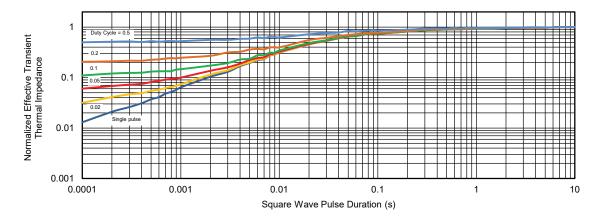
a. $V_{GS} > minimum V_{GS}$ at which $R_{DS(on)}$ is specified



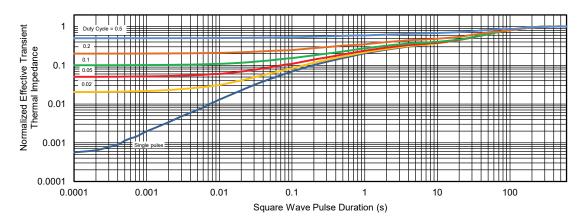
Threshold Voltage



TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

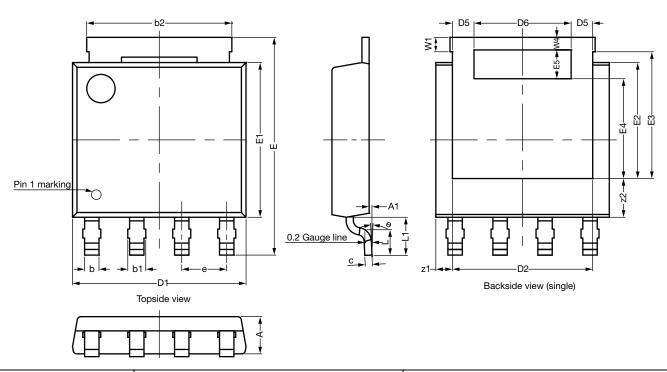
Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Case (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?77368.



PowerPAK® SO-8L (PPKSO8LWLA) Case Outline 3



DIM.		MILLIMETERS		INCHES			
DIIVI.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
Α	1.00	1.05	1.10	0.039	0.041	0.043	
A1	0.00		0.127	0.000		0.005	
b	0.33	0.41	0.49	0.013	0.016	0.019	
b1	0.43	0.51	0.59	0.017	0.020	0.023	
b2	4.00	4.10	4.20	0.157	0.161	0.165	
С	0.15	0.20	0.25	0.006	0.008	0.010	
D1	4.80	4.90	5.00	0.189	0.193	0.197	
D2	3.86	3.96	4.06	0.152	0.156	0.160	
D5	0.51	0.61	0.71	0.020	0.024	0.028	
D6	2.64	2.74	2.84	0.104	0.108	0.112	
е		1.27 BSC		0.050 BSC			
E	6.05	6.15	6.25	0.238	0.242	0.246	
E1	4.27	4.37	4.47	0.168	0.172	0.176	
E2	3.18	3.28	3.38	0.125	0.129	0.133	
E3	3.48	3.58	3.68	0.137	0.141	0.145	
E4	2.72	2.82	2.92	0.107	0.111	0.115	
E5	0.71	0.81	0.91	0.028	0.032	0.036	
L	0.62	0.72	0.82	0.024	0.028	0.032	
L1	0.92	1.07	1.22	0.036	0.042	0.048	
W1	0.31	0.41	0.51	0.012	0.016	0.020	
W4	0.31	0.36	0.41	0.012	0.014	0.016	
z1	0.37	0.47	0.57	0.015	0.019	0.022	
z2	0.99	1.09	1.19	0.039	0.043	0.047	
θ	0°		5°	0°		5°	

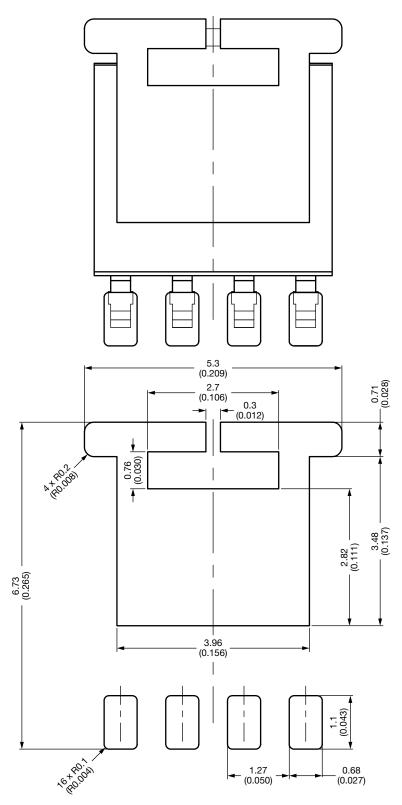
Note

• Millimeter will govern

Revison: 18-Sep-2023 1 Document Number: 76666



Recommended Land Pattern PowerPAK® SO-8L Single Short Ear



Dimensions in Millimeters (Inches)



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